

## Preliminary Information

# 900 MHz Low Voltage LVDS Clock Synthesizer

The MPC9259 is a 3.3V compatible, PLL based clock synthesizer targeted for high performance clock generation in mid-range to high-performance telecom, networking and computing applications. With output frequencies from 50 MHz to 900 MHz and the support of differential LVDS output signals the device meets the needs of the most demanding clock applications.

### Features

- 50 MHz to 900 MHz synthesized clock output signal
- Differential LVDS output
- LVCMOS compatible control inputs
- On-chip crystal oscillator for reference frequency generation
- Alternative LVCMOS compatible reference input
- 3.3V power supply
- Fully integrated PLL
- Minimal frequency overshoot
- Serial 3-wire programming interface
- Parallel programming interface for power-up
- 32 Pin LQFP Package
- SiGe Technology
- Ambient temperature range 0°C to + 70° C

### Functional Description

The internal crystal oscillator uses the external quartz crystal as the basis of its frequency reference. The frequency of the internal crystal oscillator or external reference clock signal is multiplied by the PLL. The VCO within the PLL operates over a range of 800 to 1800 MHz. Its output is scaled by a divider that is configured by either the serial or parallel interfaces. The crystal oscillator frequency  $f_{XTAL}$ , the PLL feedback-divider M and the PLL post-divider N determine the output frequency.

The feedback path of the PLL is internal. The PLL adjusts the VCO output frequency to be M times the reference frequency by adjusting the VCO control voltage. Note that for some values of M (either too high or too low) the PLL will not achieve phase lock. The PLL will be stable if the VCO frequency is within the specified VCO frequency range (800 to 1800 MHz). The M-value must be programmed by the serial or parallel interface.

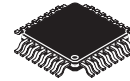
The PLL post-divider N is configured through either the serial or the parallel interfaces, and can provide one of four division ratios (1, 2, 4, or 8). This divider extends performance of the part while providing a 50% duty cycle.

The configuration logic has two sections: serial and parallel. The parallel interface uses the values at the M[6:0] and N[1:0] inputs to configure the internal counters. It is recommended on system reset to hold the P\_LOAD input LOW until power becomes valid. On the LOW-to-HIGH transition of P\_LOAD, the parallel inputs are captured. The parallel interface has priority over the serial interface. Internal pullup resistors are provided on the M[6:0] and N[1:0] inputs prevent the LVCMOS compatible control inputs from floating. The serial interface centers on a twelve bit shift register. The shift register shifts once per rising edge of the S\_CLOCK input. The serial input S\_DATA must meet setup and hold timing as specified in the AC Characteristics section of this document. The configuration latches will capture the value of the shift register on the HIGH-to-LOW edge of the S\_LOAD input. See the programming section for more information. The TEST output reflects various internal node values, and is controlled by the T[2:0] bits in the serial data stream. In order to minimize the PLL jitter, it is recommended to avoid active signal on the TEST output. The PWR\_DOWN pin, when asserted, will synchronously divide the FOUT by 16. The power down sequence is clocked by the PLL reference clock, thereby causing the frequency reduction to happen relatively slowly. Upon de-assertion of the PWR\_DOWN pin, the FOUT input will step back up to its programmed frequency in four discrete increments.

This document contains information on a product under development. Motorola reserves the right to change or discontinue this product without notice.

**MPC9259**

**900 MHZ LOW VOLTAGE  
CLOCK SYNTHESIZER**



**FA SUFFIX**  
32-LEAD LQFP PACKAGE  
CASE 873A



Table 1. Pin Configuration

Pin	I/O	Default	Type	Function
XTAL_IN, XTAL_OUT			Analog	Crystal oscillator interface
FREF_EXT	Input	0	LVC MOS	Alternative PLL reference input
FOUT, FOUT	Output		LVDS	Differential clock output
TEST	Output		LVC MOS	Test and device diagnosis output
XTAL_SEL	Input	1	LVC MOS	PLL reference select input
PWR_DOWN	Input	0	LVC MOS	Configuration input for power down mode. Assertion (deassertion) of power down will decrease (increase) the output frequency by a ratio of 16 in 4 discrete steps. PWR_DOWN assertion (deassertion) is synchronous to the input reference clock.
S_LOAD	Input	0	LVC MOS	Serial configuration control input. This inputs controls the loading of the configuration latches with the contents of the shift register. The latches will be transparent when this signal is high, thus the data must be stable on the high-to-low transition.
P_LOAD	Input	1	LVC MOS	Parallel configuration control input. this input controls the loading of the configuration latches with the content of the parallel inputs (M and N). The latches will be transparent when this signal is low, thus the parallel data must be stable on the low-to-high transition of P_LOAD. P_LOAD is state sensitive.
S_DATA	Input	0	LVC MOS	Serial configuration data input.
S_CLOCK	Input	0	LVC MOS	Serial configuration clock input.
M[0:6]	Input	1	LVC MOS	Parallel configuration for PLL feedback divider (M). M is sampled on the low-to-high transition of P_LOAD.
N[1:0]	Input	1	LVC MOS	Parallel configuration for Post-PLL divider (N). N is sampled on the low-to-high transition of P_LOAD
OE	Input	1	LVC MOS	Output enable (active high) The output enable is synchronous to the output clock to eliminate the possibility of runt pulses on the FOUT output. OE = L low stops FOUT in the logic low state (FOUT = L, FOUT = H).
GND	Supply		Ground	Negative power supply (GND).
VCC	Supply		VCC	Positive power supply for I/O and core. All VCC pins must be connected to the positive power supply for correct operation.
VCC_PLL	Supply		VCC	PLL positive power supply (analog power supply).

Table 2. Output frequency range and PLL Post-divider N

PWR_DOWN	N		VCO Output frequency division	FOUT frequency range
	1	0		
0	0	0	2	200 - 450 MHz
0	0	1	4	100 - 225 MHz
0	1	0	8	50 - 112.5 MHz
0	1	1	1	400 - 900 MHz
1	0	0	32	12.5 - 28.125 MHz
1	0	1	64	6.25 - 14.0625 MHz
1	1	0	128	3.125 - 7.03125 MHz
1	1	1	16	25 - 56.25 MHz

Table 3. Function Table

Input	0	1
XTAL_SEL	FREF_EXT	XTAL interface
OE	Outputs disabled. FOUT is stopped in the logic low state (FOUT = L, FOUT = H)	Outputs enabled
PWR_DOWN	Output divider ÷ 1	Output divider ÷16

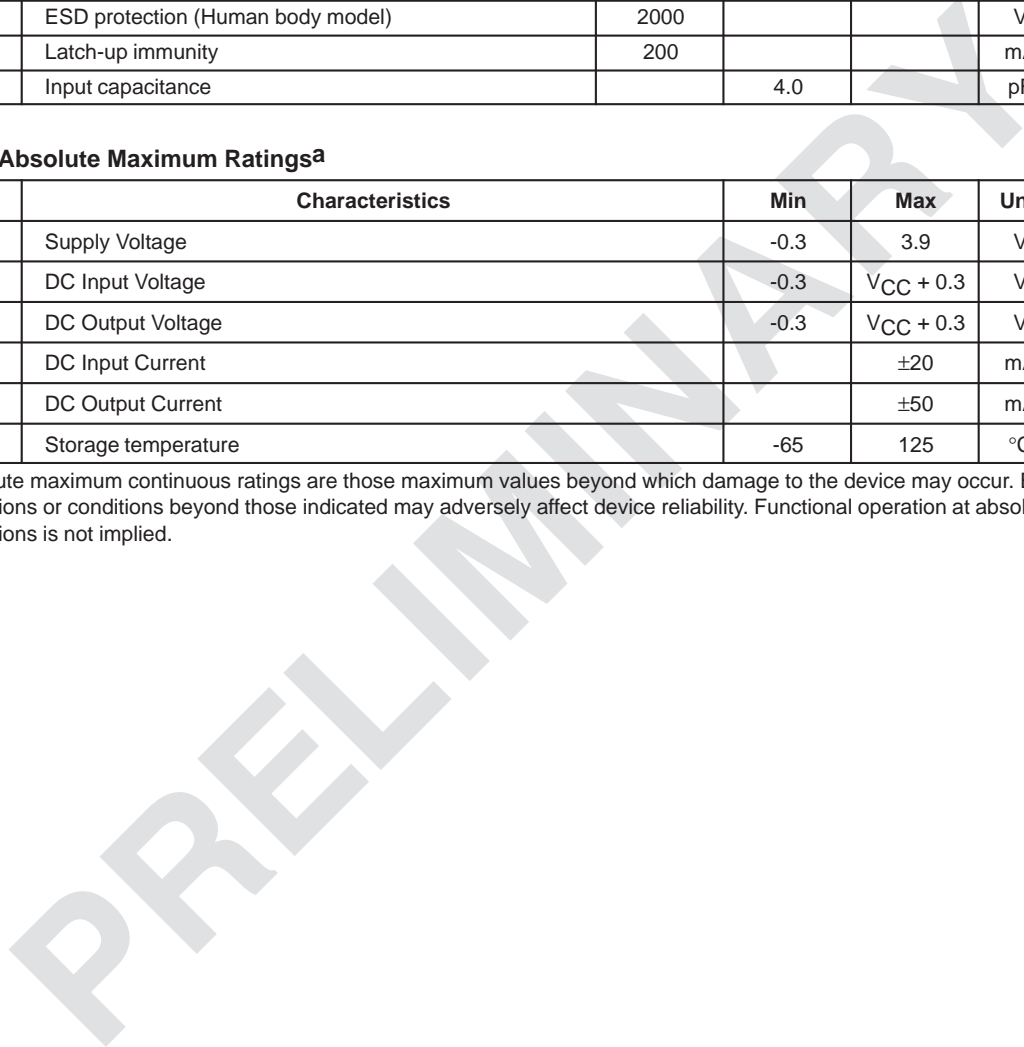
Table 4. General Specifications

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
MM	ESD protection (Machine model)	200			V	
HBM	ESD protection (Human body model)	2000			V	
LU	Latch-up immunity	200			mA	
C <sub>IN</sub>	Input capacitance		4.0		pF	Inputs

Table 5. Absolute Maximum Ratings<sup>a</sup>

Symbol	Characteristics	Min	Max	Unit	Condition
V <sub>CC</sub>	Supply Voltage	-0.3	3.9	V	
V <sub>IN</sub>	DC Input Voltage	-0.3	V <sub>CC</sub> + 0.3	V	
V <sub>OUT</sub>	DC Output Voltage	-0.3	V <sub>CC</sub> + 0.3	V	
I <sub>IN</sub>	DC Input Current		±20	mA	
I <sub>OUT</sub>	DC Output Current		±50	mA	
T <sub>S</sub>	Storage temperature	-65	125	°C	

<sup>a</sup> Absolute maximum continuous ratings are those maximum values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation at absolute-maximum-rated conditions is not implied.



**Table 6. DC Characteristics** ( $V_{CC} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  to  $+70^\circ C$ )<sup>a</sup>

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
LVCMOS control inputs (FREF_EXT, PWR_DOWN, XTAL_SEL, P_LOAD, S_LOAD, S_DATA, S_CLOCK, M[0:6], N[0:1], OE)						
V <sub>IH</sub>	Input high voltage	2.0		V <sub>CC</sub> + 0.3	V	LVCMOS
V <sub>IL</sub>	Input low voltage			0.8	V	LVCMOS
I <sub>IN</sub>	Input Current <sup>b</sup>			±200	µA	V <sub>IN</sub> = V <sub>CC</sub> or GND
Differential clock output FOUT						
V <sub>PP</sub>	Output Differential Voltage (peak-to-peak)	250			mV	LVDS
V <sub>OS</sub>	Output Offset Voltage	1125		1275	mV	LVDS
Test and diagnosis output TEST						
V <sub>OH</sub>	Output High Voltage	2.0			V	I <sub>OH</sub> = -0.8 mA
V <sub>OL</sub>	Output Low Voltage			0.55	V	I <sub>OL</sub> = 0.8 mA
Supply current						
I <sub>CC_PLL</sub>	Maximum PLL Supply Current			20	mA	V <sub>CC_PLL</sub> Pins
I <sub>CC</sub>	Maximum Supply Current			110	mA	All V <sub>CC</sub> Pins

- a. All AC characteristics are design targets and subject to change upon device characterization.  
 b. Inputs have pull-down resistors affecting the input current.

**Table 7. AC Characteristics** ( $V_{CC} = 3.3V \pm 5\%$ ,  $T_A = 0^\circ C$  to  $+70^\circ C$ )<sup>a</sup>

Symbol	Characteristics	Min	Typ	Max	Unit	Condition
f <sub>XTAL</sub>	Crystal interface frequency range	10		20	MHz	
f <sub>VCO</sub>	VCO frequency range <sup>b</sup>	800		1800	MHz	
f <sub>MAX</sub>	Output Frequency	N = 11 (+1) N = 00 (+2) N = 01 (+4) N = 10 (+8)	400 200 100 50	900 450 225 112.5	MHz MHz MHz MHz	PWR_DOWN = 0
f <sub>S_CLOCK</sub>	Serial interface programming clock frequency <sup>c</sup>	0		10	MHz	
t <sub>P,MIN</sub>	Minimum pulse width (S_LOAD, P_LOAD)	50			ns	
DC	Output duty cycle	45	50	55	%	
t <sub>r</sub> , t <sub>f</sub>	Output Rise/Fall Time	0.05		TBD	ns	20% to 80%
t <sub>S</sub>	Setup Time	S_DATA to S_CLOCK S_CLOCK to S_LOAD M, N to P_LOAD	20 20 20		ns ns ns	
t <sub>S</sub>	Hold Time	S_DATA to S_CLOCK M, N to P_LOAD	20 20		ns ns	
t <sub>JIT(CC)</sub>	Cycle-to-cycle jitter	RMS (1 σ) <sup>d</sup>		TBD	ps	
t <sub>JIT(PER)</sub>	Period Jitter	RMS (1 σ)		±25	ps	
t <sub>LOCK</sub>	Maximum PLL Lock Time			10	ms	

- a. All AC characteristics are design targets and subject to change upon device characterization.  
 b. The input frequency f<sub>XTAL</sub> and the PLL feedback divider M must match the VCO frequency range: f<sub>VCO</sub> = f<sub>XTAL</sub> · 2 · M.  
 c. The frequency of S\_CLOCK is limited to 10 MHz in serial programming mode. S\_CLOCK can be switched at higher frequencies when used as test clock in test mode 6. See application section for more details.  
 d. See application section for a jitter calculation for other confidence factors than 1 σ.

**Table 8. MPC9259 Frequency Operating Range (in MHz)**

M	M[6:0]	VCO frequency for an crystal interface frequency of						Output frequency for f <sub>X</sub> TAL=16 MHz and for N =			
		10 MHz	12 MHz	14 MHz	16 MHz	18 MHz	20 MHz	1	2	4	8
20	0010100						800				
21	0010101						840				
22	0010110						880				
23	0010111					828	920				
24	0011000					864	960				
25	0011001				800	900	1000	400	200	100	50
26	0011010				832	936	1040	416	208	104	52
27	0011011				864	972	1080	432	216	108	54
28	0011100			812	896	1008	1120	448	224	112	56
29	0011101			840	928	1044	1160	464	232	116	58
30	0011110			875	960	1080	1200	480	240	120	60
31	0011111			868	992	1116	1240	496	248	124	62
32	0100000			896	1024	1152	1280	512	256	128	64
33	0100001			924	1056	1188	1320	528	264	132	66
34	0100010		816	952	1088	1224	1360	544	272	136	68
35	0100011		840	980	1120	1260	1400	560	280	140	70
36	0100100		864	1008	1152	1296	1440	576	288	144	72
37	0100101		888	1036	1184	1332	1480	592	296	148	74
38	0100110		912	1064	1216	1368	1520	608	304	152	76
39	0100111		936	1092	1248	1404	1560	624	312	156	78
40	0101000	800	960	1120	1280	1440	1600	640	320	160	80
41	0101001	820	984	1148	1312	1476	1640	656	328	164	82
42	0101010	840	1008	1176	1344	1512	1680	672	336	168	84
43	0101011	860	1032	1204	1376	1548	1720	688	344	172	86
44	0101100	880	1056	1232	1408	1584	1760	704	352	176	88
45	0101101	900	1080	1260	1440	1620	1800	720	360	180	90
46	0101110	920	1104	1288	1472	1656		736	368	184	92
47	0101111	940	1128	1316	1504	1692		752	376	188	94
48	0110000	960	1152	1344	1536	1728		768	384	192	96
49	0110001	980	1176	1372	1568	1764		784	392	196	98
50	0110010	1000	1200	1400	1600	1800		800	400	200	100
51	0110011	1020	1224	1428	1632			816	408	204	102
52	0110100	1040	1248	1456	1664			832	416	208	104
53	0110101	1060	1272	1484	1696			848	424	212	106
54	0110110	1080	1296	1512	1728			864	432	216	108
55	0110111	1100	1320	1540	1760			880	440	220	110
56	0111000	1120	1344	1568	1792			896	448	224	112
57	0111001	1140	1368	1596							
58	0111010	1160	1392	1624							
59	0111011	1180	1416	1652							
60	0111100	1200	1440	1680							
61	0111101	1220	1488	1736							
62	0111110	1260	1512	1764							
63	0111111	1260	1512	1764							
64	1000000	1280	1536	1792							
...		...	...	...							

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**Programming the MPC9259**

Programming the MPC9259 amounts to properly configuring the internal PLL dividers to produce the desired synthesized frequency at the output. The output frequency can be represented by this formula:

$$f_{OUT} = (f_{XTAL} \div 2) \cdot (M \cdot 4) \div (N \cdot 2) \text{ or} \quad (1)$$

$$f_{OUT} = f_{XTAL} \cdot M \div N \quad (2)$$

where  $f_{XTAL}$  is the crystal frequency, M is the PLL feedback-divider and N is the PLL post-divider. The input frequency and the selection of the feedback divider M is limited by the VCO-frequency range.  $f_{XTAL}$  and M must be configured to match the VCO frequency range of 800 to 1800 MHz in order to achieve stable PLL operation:

$$M_{MIN} = f_{VCO,MIN} \div (2 \cdot f_{XTAL}) \text{ and} \quad (3)$$

$$M_{MAX} = f_{VCO,MAX} \div (2 \cdot f_{XTAL}) \quad (4)$$

For instance, the use of a 16 MHz input frequency requires the configuration of the PLL feedback divider between  $M = 25$  and  $M = 56$ . Table 8 shows the usable VCO frequency and M divider range for other example input frequencies. Assuming that a 16 MHz input frequency is used, equation (2) reduces to:

$$f_{OUT} = 16 M \div N \quad (5)$$

Substituting N for the four available values for N (1, 2, 4, 8) yields:

**Table 9. Output Frequency Range for  $f_{XTAL} = 16$  MHz**

N			FOUT	FOUT range	FOUTstep
1	0	Value			
0	0	2	8-M	200-450 MHz	8 MHz
0	1	4	4-M	100-225 MHz	4 MHz
1	0	8	2-M	50-112.5 MHz	2 MHz
1	1	1	16-M	400-900 MHz	16 MHz

**Example calculation for an 16 MHz input frequency**

For example, if an output frequency of 384 MHz was desired, the following steps would be taken to identify the appropriate M and N values. 384 MHz falls within the frequency range set by an N value of 2, so  $N[1:0]=00$ . For  $N = 2$ ,  $F_{OUT} = 8 \cdot M$  and  $M = F_{OUT} \div 8$ . Therefore,  $M = 384 \div 8 = 48$ , so  $M[6:0] = 0110000$ . Following this procedure a user can generate any whole frequency between 50 MHz and 900 MHz. The size of the programmable frequency steps will be equal to:

$$f_{STEP} = f_{XTAL} \div N \quad (6)$$

**Using the parallel and serial interface**

The M and N counters can be loaded either through a parallel or serial interface. The parallel interface is controlled via the P\_LOAD signal such that a LOW to HIGH transition will latch the information present on the  $M[6:0]$  and  $N[1:0]$  inputs into the M and N counters. When the P\_LOAD signal is LOW the input latches will be transparent and any changes on the  $M[6:0]$  and  $N[1:0]$  inputs will affect the FOUT output pair. To use the serial port the S\_CLOCK signal samples the information on the S\_DATA line and loads it into a 12 bit shift register. Note that the P\_LOAD signal must be HIGH for the serial load operation to function. The Test register is loaded with the first three bits, the N register with the next two, and the M register with the final eight bits of the data stream on the S\_DATA input. For each register the most significant bit is loaded first (T2, N1 and M6). A pulse on the S\_LOAD pin after the shift register is fully loaded will transfer the divide values into the counters. The HIGH to LOW transition on the S\_LOAD input will latch the new divide values into the counters. Figure 3 illustrates the timing diagram for both a parallel and a serial load of the MPC9259 synthesizer.

$M[6:0]$  and  $N[1:0]$  are normally specified once at power-up through the parallel interface, and then possibly again through the serial interface. This approach allows the application to come up at one frequency and then change or fine-tune the clock as the ability to control the serial interface becomes available.

**Using the test and diagnosis output TEST**

The TEST output provides visibility for one of the several internal nodes as determined by the  $T[2:0]$  bits in the serial configuration stream. It is not configurable through the parallel interface. Although it is possible to select the node that represents FOUT, the LVCMOS output is not able to toggle fast enough for higher output frequencies and should only be used for test and diagnosis.

The  $T_2$ ,  $T_1$  and  $T_0$  control bits are preset to '000' when P\_LOAD is LOW so that the PECL FOUT outputs are as jitter-free as possible. Any active signal on the TEST output pin will have detrimental affects on the jitter of the PECL output pair. In normal operations, jitter specifications are only guaranteed if the TEST output is static. The serial configuration port can be used to select one of the alternate functions for this pin.

Most of the signals available on the TEST output pin are useful only for performance verification of the MPC9259 itself. However, the PLL bypass mode may be of interest at the board level for functional debug. When  $T[2:0]$  is set to 110 the MPC9259 is placed in PLL bypass mode. In this mode the S\_CLOCK input is fed directly into the M and N dividers. The N divider drives the FOUT differential pair and the M counter drives the TEST output pin. In this mode the S\_CLOCK input could be used for low speed board level functional test or debug. Bypassing the PLL and driving FOUT directly gives the user more control on the test clocks sent through the clocktree shows the functional setup of the PLL bypass mode. Because the S\_CLOCK is a CMOS level the input frequency is limited to 200 MHz. This means the fastest the FOUT pin can be toggled via the S\_CLOCK is 100 MHz as the divide ratio of the Post-PLL divider is 2 (if  $N = 1$ ). Note that the M counter output on the TEST output will not be a 50% duty cycle.



Table 10. Test and Debug Configuration for TEST

T[2:0]			TEST output
T2	T1	T0	
0	0	0	12-bit shift register out <sup>a</sup>
0	0	1	Logic 1
0	1	0	$f_{XTAL} \div 2$
0	1	1	M-Counter out
1	0	0	FOUT
1	0	1	Logic 0
1	1	0	M-Counter out in PLL-bypass mode
1	1	1	$FOUT \div 4$

a. Clocked out at the rate of S\_CLOCK

Table 11. Debug Configuration for PLL bypass<sup>a</sup>

Output	Configuration
FOUT	$S\_CLOCK \div N$
TEST	M-Counter out <sup>b</sup>

- a. T[2:0] = 110. AC specifications do not apply in PLL bypass mode
- b. Clocked out at the rate of  $S\_CLOCK \div (2 \cdot N)$

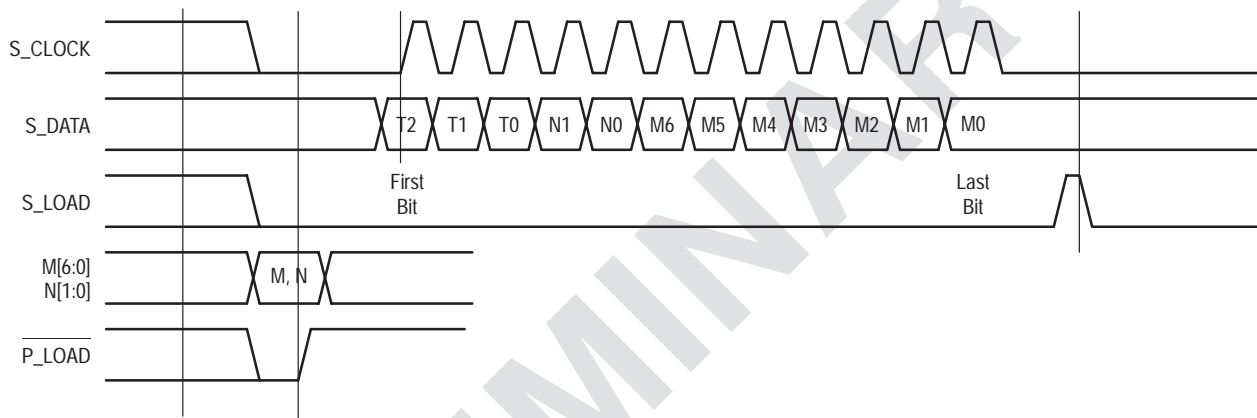


Figure 3. Serial Interface Timing Diagram

Power Supply Filtering

The MPC9259 is a mixed analog/digital product and as such it exhibits some sensitivities that would not necessarily be seen on a fully digital product. Analog circuitry is naturally susceptible to random noise, especially if this noise is seen on the power supply pins. The MPC9259 provides separate power supplies for the digital circuitry (VCC) and the internal PLL (VCC\_PLL) of the device. The purpose of this design technique is to try and isolate the high switching noise digital outputs from the relatively sensitive internal analog phase-locked loop. In a controlled environment such as an evaluation board, this level of isolation is sufficient. However, in a digital system environment where it is more difficult to minimize noise on the power supplies a second level of isolation may be required. The simplest form of isolation is a power supply filter on the VCC\_PLL pin for the MPC9259. Figure 4 illustrates a typical power supply filter scheme. The MPC9259 is most susceptible to noise with spectral content in the 1 kHz to 1 MHz range. Therefore, the filter should be designed to target this range. The key parameter that needs to be met in the final filter design is the DC voltage drop that will be seen between the VCC supply and the MPC9259 pin of the MPC9259. From the data sheet, the VCC\_PLL current (the current sourced through the VCC\_PLL pin) is typically TBD mA (TBD maximum), assuming that a minimum of 3.135V must be maintained on the VCC\_PLL pin, very little DC voltage drop can be tolerated when a 3.3V VCC supply is used. The resistor shown in Figure 4 must have a resistance of TBD  $\Omega$  to

meet the voltage drop criteria. The RC filter pictured will provide a broadband filter with approximately 100:1 attenuation for noise whose spectral content is above 20 kHz. As the noise frequency crosses the series resonant point of an individual capacitor its overall impedance begins to look inductive and thus increases with increasing frequency. The parallel capacitor combination shown ensures that a low impedance path to ground exists for frequencies well above the bandwidth of the PLL. Generally, the resistor/capacitor filter will be cheaper, easier to implement and provide an adequate level of supply filtering. A higher level of attenuation can be achieved by replacing the resistor with an appropriate valued inductor. A 1000  $\mu$ H choke will show a significant impedance at 10 kHz frequencies and above. Because of the current draw and the voltage that must be maintained on the VCC\_PLL pin, a low DC resistance inductor is required (less than TBD  $\Omega$ ).

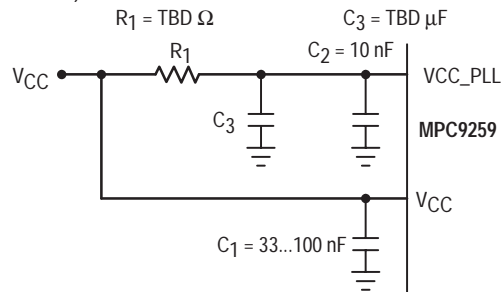
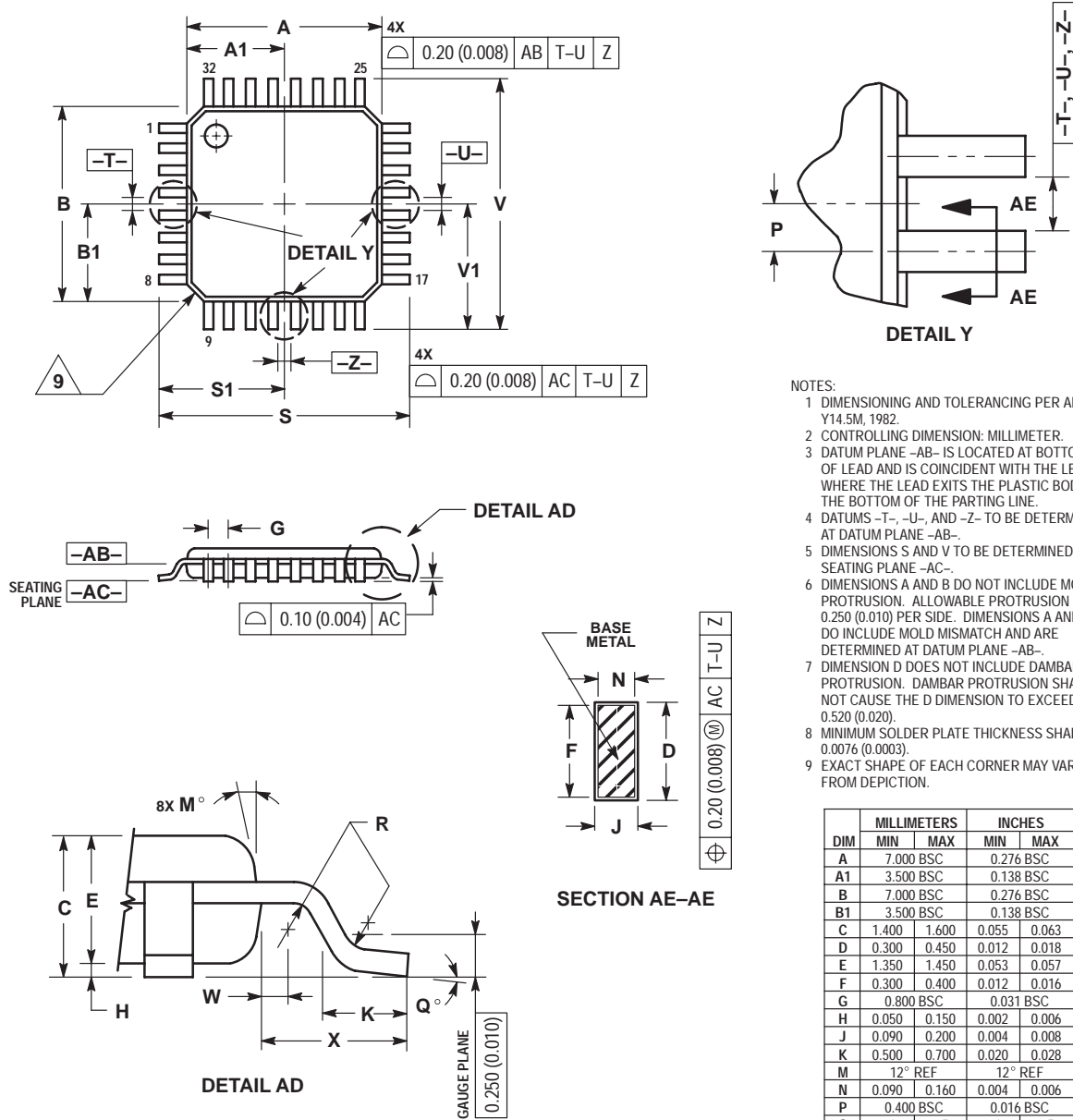


Figure 4. VCC\_PLL Power Supply Filter



OUTLINE DIMENSIONS

FA SUFFIX  
LQFP PACKAGE  
CASE 873A-02  
ISSUE A



- NOTES:
- 1 DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - 2 CONTROLLING DIMENSION: MILLIMETER.
  - 3 DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
  - 4 DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
  - 5 DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.
  - 6 DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
  - 7 DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.520 (0.020).
  - 8 MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).
  - 9 EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.000 BSC	0.276 BSC		
A1	3.500 BSC	0.138 BSC		
B	7.000 BSC	0.276 BSC		
B1	3.500 BSC	0.138 BSC		
C	1.400	1.600	0.055	0.063
D	0.300	0.450	0.012	0.018
E	1.350	1.450	0.053	0.057
F	0.300	0.400	0.012	0.016
G	0.800 BSC	0.031 BSC		
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.500	0.700	0.020	0.028
M	12° REF	12° REF		
N	0.090	0.160	0.004	0.006
P	0.400 BSC	0.016 BSC		
Q	1°	5°	1°	5°
R	0.150	0.250	0.006	0.010
S	9.000 BSC	0.354 BSC		
S1	4.500 BSC	0.177 BSC		
V	9.000 BSC	0.354 BSC		
V1	4.500 BSC	0.177 BSC		
W	0.200 REF	0.008 REF		
X	1.000 REF	0.039 REF		

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**NOTES**

**NOTES**

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